

## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	ADJUSTABLE IMPEDANCE CIRCUIT		
Application Number :			
Date :			
First Named Applicant:		Chao-Cheng Lee	
Confirmation Number:			
Attorney Docket Number:		REAP0004USA	
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Documents being submitted:	Files
us-fee-sheet	REAP0004-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	REAP0004-usdecl.xml us-declaration.dtd us-declaration.xsl
us-power-of-attorney-grant	REAP0004-uspoat.xml us-power-of-attorney-grant.dtd us-power-of-attorney-grant.xsl
us-assignment	REAP0004-usassn.xml us-assignment.xsl us-assignment.dtd REAP0004ASS1.tif REAP0004ASS2.tif
us-request	REAP0004-usrequ.xml us-request.dtd us-request.xsl
us-declaration	REAP0004DEC1.tif
us-declaration	REAP0004DEC2.tif
application-body	REAP0004-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd 001.tif 002.tif

003.tif  
Reap0004usa-01.tif  
Reap0004usa-02.tif  
Reap0004usa-03.tif  
Reap0004usa-04.tif

Comments